

## **Technical Data Sheet**

## 0603 Package Chip LED (0.8mm Height)

## 19-21/G6C-BM1N2BZ/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-Free.

#### **Descriptions**

- The 19-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

#### **Device Selection Guide**

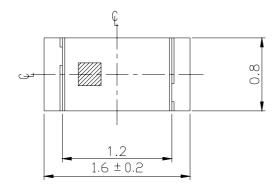
D. ANI	C	I a con Cala	
Part No.	Material	<b>Emitted Color</b>	Lens Color
19-21/G6C-BM1N2BZ/3T	AlGaInP	<b>Brilliant Yellow</b>	Water Clear
	AlGailli	Green	water Clear

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 1 of 10

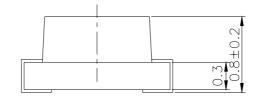
Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang



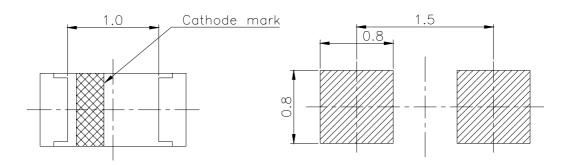
## **Package Outline Dimensions**







For reflow soldering



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

Everlight Electronics Co., Ltd.

Device No.: DSE-191-G12

Prepared date: 07-DEC-2004

http://www.everlight.com

Rev.1.0

Page: 2 of 10

Prepared by: Jessica Chang



## **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	<b>I</b> F	25	mA
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$ C
Soldering Temperature	Tsol	260 (for 5 seconds)	$^{\circ}$ C
Electrostatic Discharge	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA

## **Electro-Optical Characteristics (Ta=25°C)**

		`	- /			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	18.0		45.0	mcd	
Peak Wavelength	λр		575		nm	
Dominant Wavelength	λd	567.5		575.5	nm	
Spectrum Radiation Bandwidth	Δλ		20		nm	I <sub>F</sub> =10mA
Viewing Angle	2 \theta 1/2		100		deg	
Forward Voltage	VF	1.75		2.35	V	
Reverse Current	Ir			10	μΑ	V <sub>R</sub> =5V

#### **Notes:**

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 3 of 10

Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang



## Bin Rang Of Dom. Wavelength

Groups	Bin	Min	Max	Unit	Condition	
В	C15	567.5	569.5			
	C16	569.5	571.5		IF=10mA	
	C17	571.5	573.5	nm		
	C18	573.5	575.5			

#### **Bin Rang Of Luminous Intensity**

Bin	Min	Max	Unit	Condition	
M1	18.0	22.5	mcd		
M2	22.5	28.5		IF=10mA	
N1	28.5	36.0			
N2	36.0	45.0			

#### **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition	
	0	1.75	1.95			
В	1	1.95	2.15	V	IF=10mA	
	2	2.15	2.35		1	

#### **Notes:**

1.Tolerance of Luminous Intensity ±10%

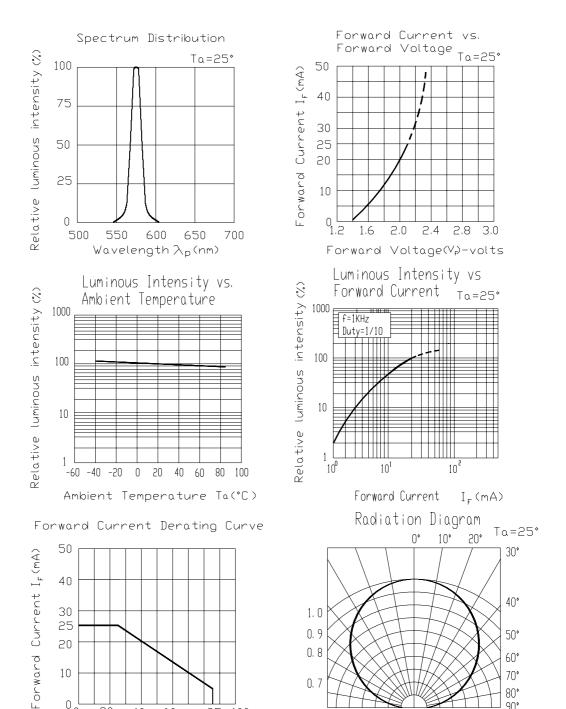
2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 4 of 10 Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang

80°

## **Typical Electro-Optical Characteristics Curves**



Everlight Electronics Co., Ltd. Rev.1.0 Page: 5 of 10 http://www.everlight.com Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang

0. 3

0. 1

0. 2

0. 4 0.6

100

60

Ambient Temperature Ta(°C)

#### Label explanation

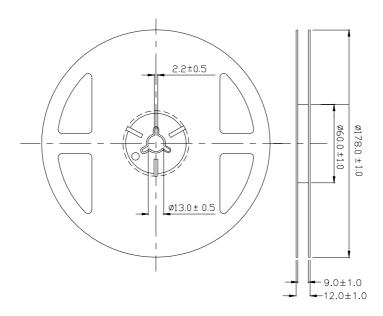
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**

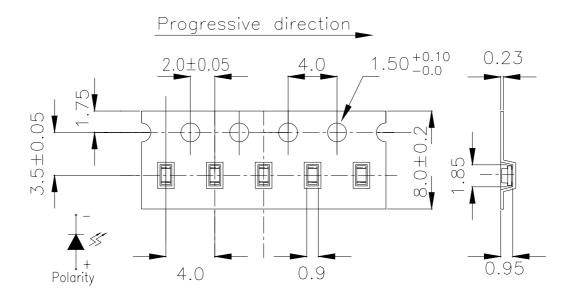


**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 6 of 10 Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang

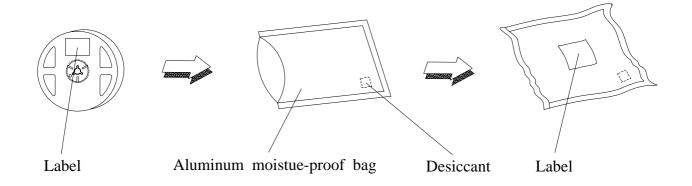


## Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

## **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd.

Device No.: DSE-191-G12

http://www.everlight.com Prepared date: 07-DEC-2004 Rev.1.0

Page: 7 of 10

Prepared by: Jessica Chang



## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C  Min. 5sec.  6 Min.		22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°€	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 8 of 10 Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang

#### **Precautions For Use**

1. Over-current-proof

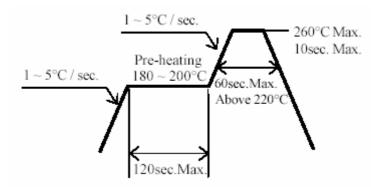
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 9 of 10 Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang

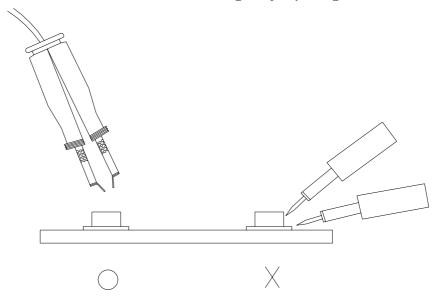


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1.0 Page: 10 of 10

Device No.: DSE-191-G12 Prepared date: 07-DEC-2004 Prepared by: Jessica Chang